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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/822,522

04/12/2004

Hui-Jye Hshieh

24061.123  
(TSMC2003-0744)

3356

42717 7590 01/18/2007  
HAYNES AND BOONE, LLP  
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EXAMINER

KASENGE, CHARLES R

ART UNIT

PAPER NUMBER

2125

SHORTENED STATUTORY PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE
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3 MONTHS

01/18/2007

PAPER

**Please find below and/or attached an Office communication concerning this application or proceeding.**

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

**Office Action Summary**

Application No.

10/822,522

Applicant(s)

HSHIEH ET AL.

Examiner

Charles R. Kasenge

Art Unit

2125

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

**Status**

- 1) ☒ Responsive to communication(s) filed on 06 November 2006.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

**Disposition of Claims**

- 4) ☒ Claim(s) 1-30 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☒ Claim(s) 6 is/are allowed.
- 6) ☒ Claim(s) 1-3, 5, 7-18, 20 and 22-30 is/are rejected.
- 7) ☒ Claim(s) 4, 19 and 21 is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

**Application Papers**

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 21 April 2004 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.  
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).  
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

**Priority under 35 U.S.C. § 119**

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
  2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

**Attachment(s)**

- |  |   |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892)          | 4) <input type="checkbox"/> Interview Summary (PTO-413)           |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____                                      |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)          | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____  | 6) <input type="checkbox"/> Other: _____                          |

## **DETAILED ACTION**

### ***Response to Arguments***

1. Applicant's arguments, see Remarks, filed 11/6/06, with respect to the rejection(s) of the claim(s) have been fully considered and are persuasive. Therefore, the rejection has been withdrawn. However, upon further consideration, a new ground(s) of rejection is made in view of Matsuda U.S. Patent Application Publication 2002/0143650.

### ***Claim Rejections - 35 USC § 102***

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

3. Claims 1-3, 5, 7-18, 20 and 22-30 are rejected under 35 U.S.C. 102(e) as being anticipated by Matsuda U.S. Patent Application Publication 2002/0143650. Regarding claims 1 and 16, Matsuda discloses a method of communicating semiconductor manufacturing information (abstract), the method comprising: providing, by a first service provider, a lot of semiconductor components to a second service provider for processing (pg. 2, ¶21); receiving, by the first service provider, first information associated with the processing, from the second service provider (pg. 2, ¶23 and Fig. 1, #22); generating, by the first service provider, second information responsive to the first information (pg. 2, ¶24 and Fig. 1, #25) and outputting, by the first service provider, second information determined in response to the first information, to a

customer affiliated with the second service provider (pg. 2, ¶22).

Regarding claims 2, 3, 5, 17, 18 and 20, Matsuda discloses the method of claim 1 further comprising: in association with providing the lot of semiconductor components to the second service provider for processing, providing, by the first service provider, a virtual work order to the second service provider (pg. 2, ¶21). Matsuda discloses the method of claim 1, wherein the first service provider and the second service provider are separate business organizations (Fig. 1, #1 and 2). Matsuda discloses the method of claim 1, wherein the first information includes work-in-process ("WIP") information (pg. 5 and 6, ¶42 and 51).

Regarding claims 7-9 and 22-24, Matsuda discloses the method of claim 5, wherein receiving the WIP information is by periodically receiving the WIP information, in response to passage of a predetermined period of time (pg. 4, ¶37). Matsuda discloses the method of claim 1, wherein the first information includes shipping information (pg. 5, ¶41). Matsuda discloses the method of claim 1, wherein the first information includes lot yield information (pg. 2, ¶21).

Regarding 10-15 and 25-30, Matsuda discloses the method of claim 1, wherein receiving the first information and outputting the second information are by receiving and outputting through a network (pg. 2, ¶27). Matsuda discloses the method of claim 10, wherein the network is a global computer network (pg. 2, ¶27). Matsuda discloses the method of claim 10, wherein receiving the first information and outputting the second information are by receiving and outputting using the file transfer protocol ("FTP") (pg. 2, ¶27). Matsuda discloses the method of claim 10, wherein receiving the first information and outputting the second information are by receiving and outputting using the hyper text transfer protocol ("HTTP") (pg. 2, ¶27). Matsuda discloses the method of claim 1, wherein the lot of semi-conductor components is a lot of

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integrated chips ("IC's") (pg. 2, ¶21). Matsuda discloses the method of claim 1, wherein the second information includes the first information (pg. 2, ¶21).

***Allowable Subject Matter***

4. Claim 6 is allowed.
5. Claims 4, 19 and 21 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

***Conclusion***

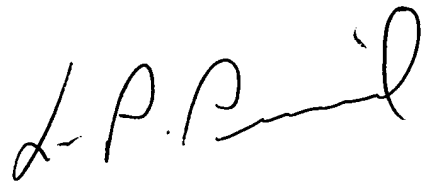
Any inquiry concerning this communication or earlier communications from the examiner should be directed to Charles R. Kasenge whose telephone number is 571 272-3743. The examiner can normally be reached on Monday through Friday, 8:30 - 5 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Leo Picard can be reached on 571 272-3749. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

CK  
January 10, 2007

A handwritten signature in black ink, appearing to read 'L. P. Picard', with a stylized flourish at the end.

**LEO PICARD  
SUPERVISORY PATENT EXAMINER  
TECHNOLOGY CENTER 2100**